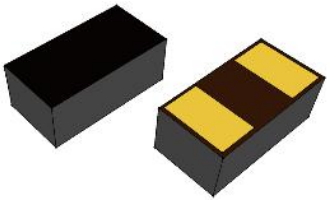
2. Pin Description



. 3

4. Schematic

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8. Typical Characteristics

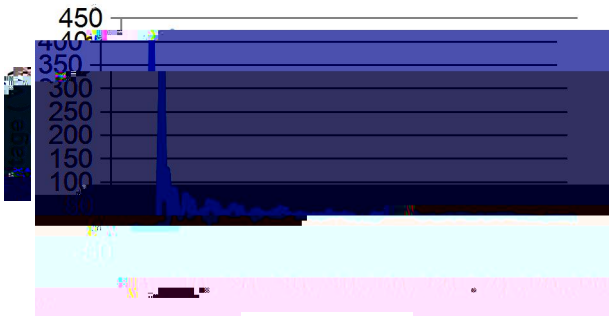


Fig.1 Typical ESD Response
IEC 61000-4-2, ？ 4contact discharge

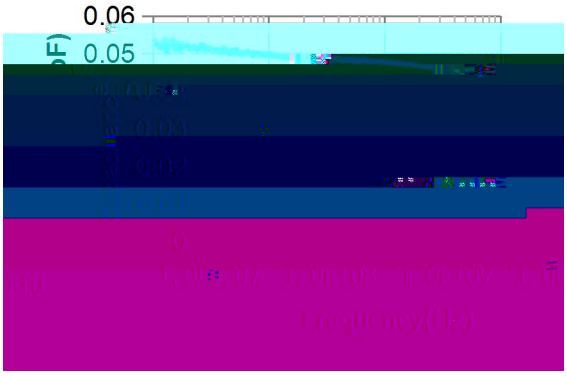


Fig.2 Typical Device Capacitance VS. Frequency

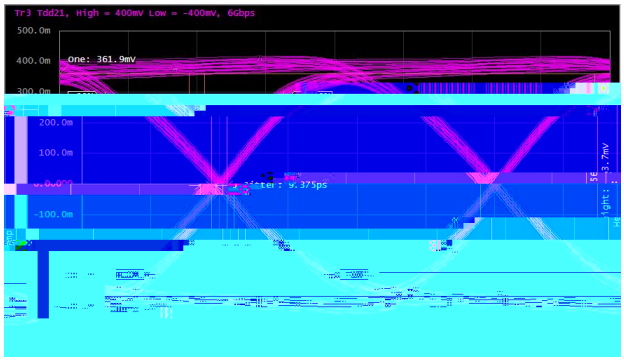
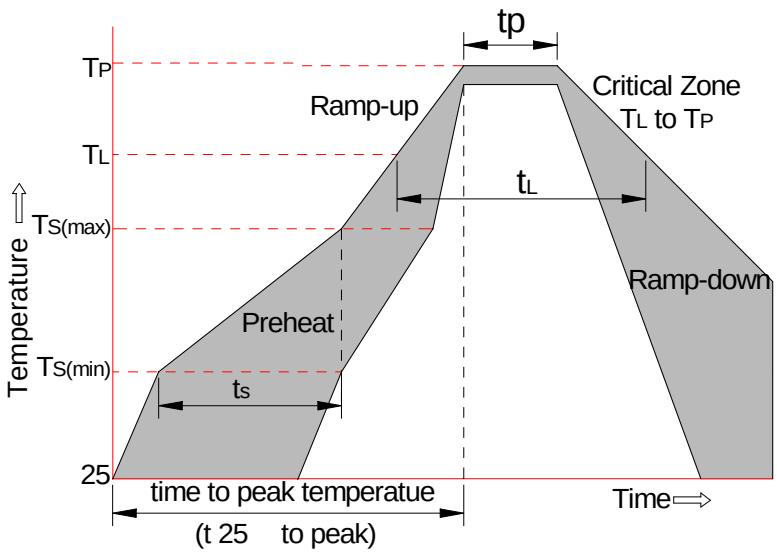


Fig.3 HDMI 2.0 Mask at 6.0 Gbps

9. ESD Protection for Signal Line

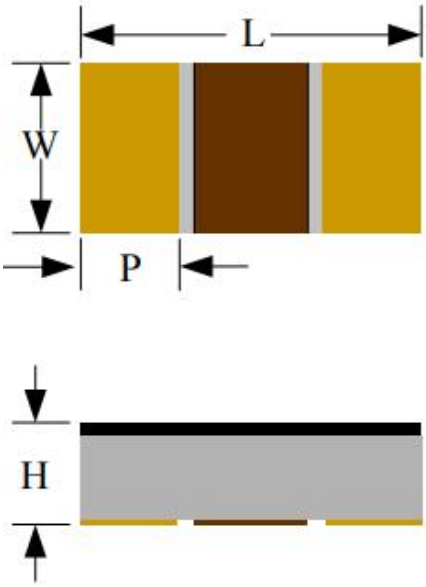
The PESD is designed for the protection of one bidirectional data line from ESD damage. ’ Ův/ d `

10. Soldering Parameters

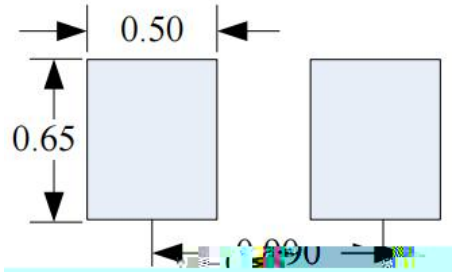


Reflow

1 . Package Dimension



Recommended Solder Pad Footprint



***Sizes in mm**

Notes

This solder pad layout is for reference purposes only.

Dimension	Unit: Millimeters	
	Min.	Max.
L	0.90	1.10
W	0.42	0.62
P	0.15	0.35
H	0.25	0.45

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